

RGTV60TK65

650V 30A Field Stop Trench IGBT

V _{CES}	650V
I _{C (100°C)}	20A
V _{CE(sat) (Typ.)}	1.5V@I _C =30A
P_D	76W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) High Speed Switching & Low Switching Loss
- 3) Short Circuit Withstand Time 2µs
- 4) Pb free Lead Plating; RoHS Compliant

Applications

Solar Inverter

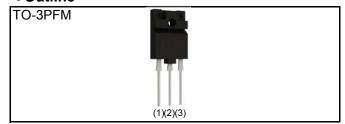
UPS

Welding

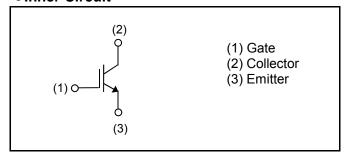
ΙH

PFC

Outline



●Inner Circuit



Packaging Specifications

	Packaging	Tube	
	Reel Size (mm)	-	
Typo	Tape Width (mm)	-	
Туре	Basic Ordering Unit (pcs)	450	
	Packing Code	C11	
	Marking	RGTV60TK65	

● Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit	
Collector - Emitter Voltage		V _{CES}	650	V	
Gate - Emitter Voltage		V_{GES}	±30	V	
Collector Current	T _C = 25°C	I _C	33	А	
	T _C = 100°C	I _C	20	А	
Pulsed Collector Current		I _{CP} *1	120	А	
Power Dissipation	T _C = 25°C	P _D	76	W	
	T _C = 100°C	P _D	38	W	
Operating Junction Temperature		T _j	-40 to +175	°C	
Storage Temperature		T _{stg}	-55 to +175	°C	

^{*1} Pulse width limited by T_{imax}.

●Thermal Resistance

Parameter	Symbol	Values			Unit
r ai ai iletei		Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	1	ı	1.97	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
r ai ai ii etei	Syllibol		Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_{C} = 10 \mu A, V_{GE} = 0 V$	650	-	-	V
Collector Cut - off Current	I _{CES}	V _{CE} = 650V, V _{GE} = 0V	1	1	10	μΑ
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, V_{CE} = 0V$	-	-	±200	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 21.0 \text{mA}$	5.0	6.0	7.0	V
Collector - Emitter Saturation Voltage	V _{CE(sat)}	$I_C = 30A$, $V_{GE} = 15V$ $T_j = 25^{\circ}C$ $T_j = 175^{\circ}C$	-	1.5 1.85	1.9 -	٧

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Darameter	Symbol	Conditions	Values			Linit
Parameter	1 arameter Symbol Conditions		Min.	Тур.	Max.	Unit
Input Capacitance	C _{ies}	V _{CE} = 30V	-	1730	-	
Output Capacitance	C _{oes}	V _{GE} = 0V	-	74	-	pF
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	30	-	
Total Gate Charge	Q_g	V _{CE} = 400V	-	64	-	
Gate - Emitter Charge	Q_{ge}	I _C = 30A	-	14	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	24	-	
Turn - on Delay Time	t _{d(on)}	I _C = 30A, V _{CC} = 400V	-	33	-	
Rise Time	t _r	$V_{GE} = 15V, R_{G} = 10\Omega$	-	12	-	20
Turn - off Delay Time	t _{d(off)}	T _j = 25°C	-	105	-	ns
Fall Time	t _f	Inductive Load	-	40	-	
Turn - on Switching Loss	E _{on}	*E _{on} includes diode	-	0.57	-	m l
Turn - off Switching Loss	E _{off}	reverse recovery	-	0.50	-	mJ
Turn - on Delay Time	t _{d(on)}	I _C = 30A, V _{CC} = 400V	-	32	-	
Rise Time	t _r	$V_{GE} = 15V, R_{G} = 10\Omega$	-	13	-	20
Turn - off Delay Time	$t_{d(off)}$	T _j = 175°C	-	121	-	ns
Fall Time	t _f	Inductive Load	-	80	-	
Turn - on Switching Loss	E _{on}	*E _{on} includes diode	-	0.63	-	m l
Turn - off Switching Loss	E _{off}	reverse recovery	-	0.72	-	mJ
		I _C = 120A, V _{CC} = 520V				
Reverse Bias Safe Operating Area	RBSOA	$V_P = 650V, V_{GE} = 15V$	FULL SQUARE			-
		$R_G = 100\Omega, T_j = 175^{\circ}C$				
		$V_{CC} \le 360V$				
Short Circuit Withstand Time	t _{sc}	V _{GE} = 15V	2	-	-	μs
		T _j = 25°C				

Fig.1 Power Dissipation vs. Case Temperature

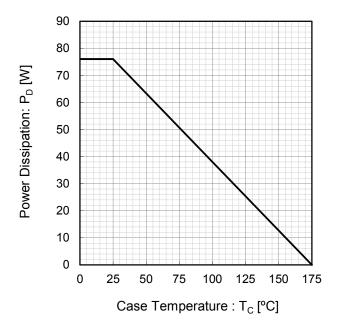


Fig.2 Collector Current vs. Case Temperature

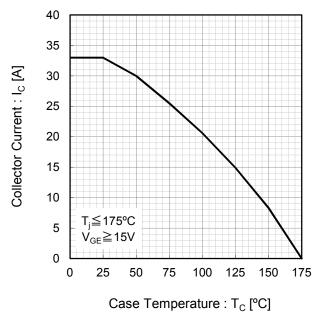


Fig.3 Forward Bias Safe Operating Area

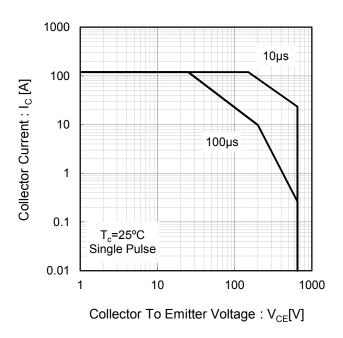


Fig.4 Reverse Bias Safe Operating Area

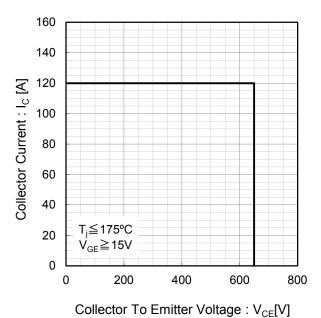


Fig.5 Typical Output Characteristics

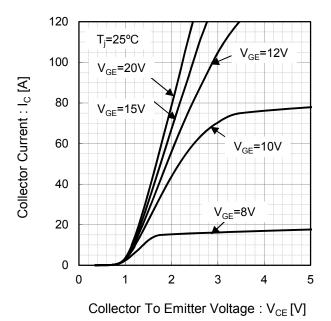
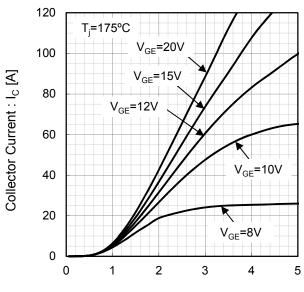


Fig.6 Typical Output Characteristics



Collector To Emitter Voltage : V_{CE} [V]

Fig.7 Typical Transfer Characteristics

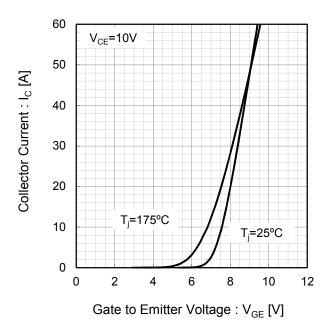


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature

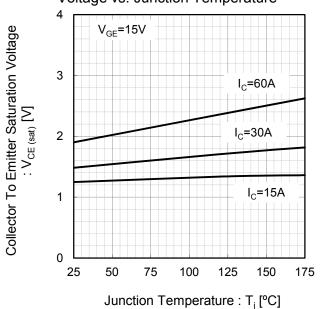


Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

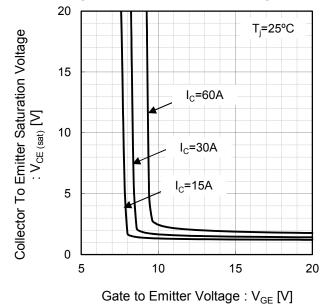
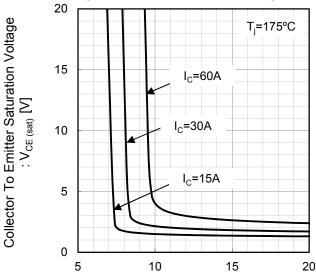


Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate to Emitter Voltage : V_{GE} [V]

Fig.11 Typical Switching Time vs. Collector Current

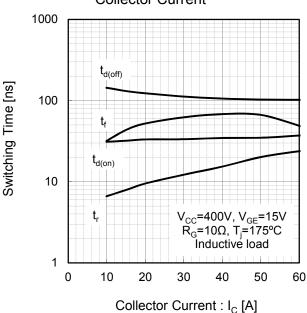


Fig.12 Typical Switching Time vs. Gate Resistance

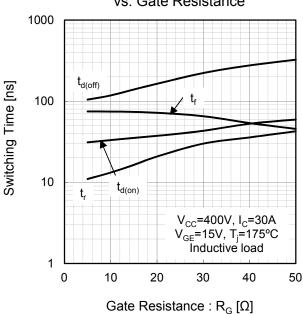


Fig.13 Typical Switching Energy Losses vs. Collector Current 10 Switching Energy Losses [mJ] 1 $\mathsf{E}_{\mathsf{off}}$ E_{on} 0.1 V_{CC} =400V, V_{GE} =15V R_{G} =10 Ω , T_{j} =175°C Inductive load 0.01 0 10 20 30 40 50 60 Collector Current : I_C [A]

Fig.14 Typical Switching Energy Losses vs. **Gate Resistance** 10 Switching Energy Losses [mJ] $\mathsf{E}_{\mathsf{off}}$ 1 E_{on} 0.1 $V_{\rm CC}$ =400V, $I_{\rm C}$ =30A $V_{\rm GE}$ =15V, $T_{\rm j}$ =175°C Inductive load 0.01 10 0 20 30 40 50

Gate Resistance : $R_G [\Omega]$

Fig.15 Typical Capacitance vs.
Collector To Emitter Voltage 10000 Cies 1000 Capacitance [pF] Coes 100 Cres 10 f=1MHz V_{GE}=0V T_i=25°C 0.01 0.1 1 10 100 Collector To Emitter Voltage : $V_{CE}[V]$

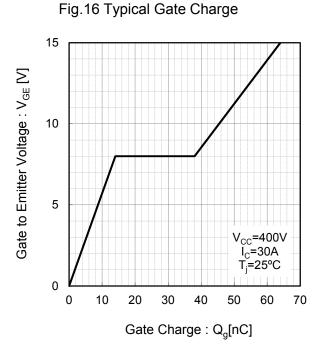
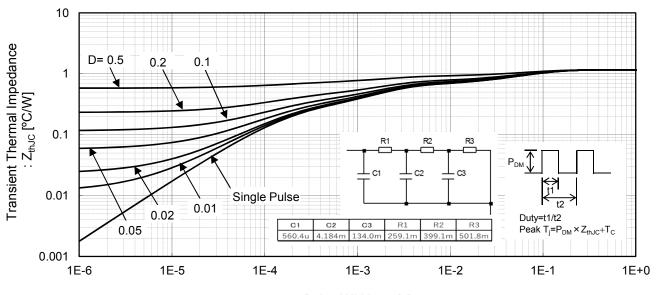


Fig.17 Typical IGBT Transient Thermal Impedance



•Inductive Load Switching Circuit and Waveform

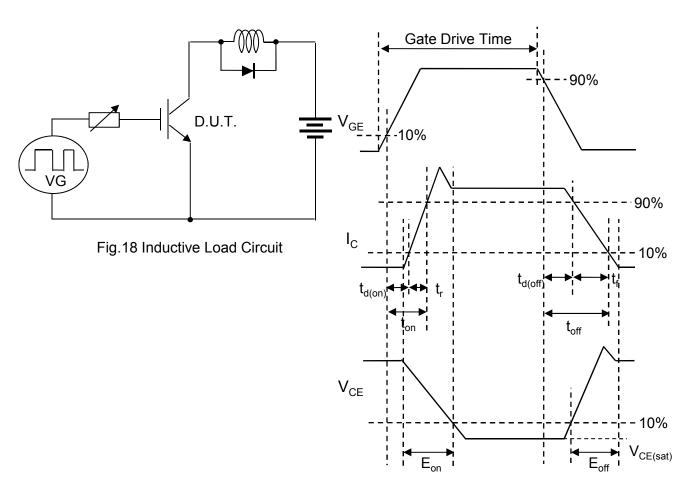


Fig.19 Inductive Load Waveform

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 NTE3320
 IHFW40N65R5SXKSA1
 APT70GR120J
 APT35GP120JDQ2

 IKZA40N65RH5XKSA1
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 IKFW50N65ES5XKSA1
 IKFW50N65EH5XKSA1
 IKFW40N65ES5XKSA1

 IKFW60N65ES5XKSA1
 IMBG120R090M1HXTMA1
 IMBG120R220M1HXTMA1
 XD15H120CX1
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 HGTG40N60B3
 FGH60N60SMD_F085

 FGH75T65UPD
 STGWA15H120F2
 IKA10N60TXKSA1
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